



40V COMPLEMENTARY ENHANCEMENT MODE MOSFET H-BRIDGE

Product Summary

| Device | V _{(BR)DSS} | R _{DS(ON)} max | I _D max T _A = +25°C |
|---------------|----------------------|---------------------------------|--|
| N Channal | 40\/ | $45m\Omega$ @ V_{GS} = $10V$ | 4.5A |
| N-Channel 40V | | $58m\Omega$ @ V_{GS} = $4.5V$ | 4A |
| P-Channel | -40V | 65mΩ @ V _{GS} = -10V | -3.7A |
| r-Granner | -4 0V | 100mΩ @ V _{GS} = -4.5V | -2.9A |

Description

This new generation complementary MOSFET H-Bridge features low on-resistance achievable with low gate drive.

Applications

- DC Motor Control
- DC-AC Inverters

Features

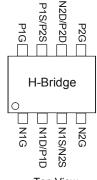
- 2 x N + 2 x P channels in a SOIC package
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

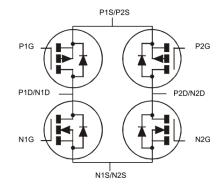
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight: 0.074 grams (approximate)







Top View Pin Configuration



Internal Schematic

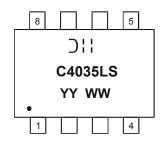
Ordering Information (Note 4)

| Part Number | Compliance | Case | Packaging |
|----------------|------------|------|------------------|
| DMHC4035LSD-13 | Standard | SO-8 | 2500/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Oll = Manufacturer's Marking
C4035LS = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 13 = 2013)
WW = Week (01 - 53)



Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

| Characteristic | Symbol | Value | Units | | |
|--|----------------|-----------------------------------|-------------|------|--|
| Total Power Dissipation (Note 5) | P_{D} | 1.5 | W | | |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | Б | 85 | | |
| Thermal Resistance, Junction to Ambient (Note 5) | t<10s | $R_{	hetaJA}$ | 53 | °C/W | |
| Thermal Resistance, Junction to Case | $R_{	heta JC}$ | 15 | | | |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +150 | °C | |

Maximum Ratings N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Units | |
|--|-----------------|--|------------------|------------|---|
| Drain-Source Voltage | | V_{DSS} | 40 | V | |
| Gate-Source Voltage | | | V _{GSS} | ±20 | V |
| Continuous Drain Correct (Note 5) / - 40) | Steady State | T _A = +25°C T _A = +70°C | I _D | 4.5 3.5 | A |
| Continuous Drain Current (Note 5) V _{GS} = 10V | t<10s | $T_A = +25$ °C $T_A = +70$ °C | I _D | 5.8 4.5 | А |
| Continuous Drain Correct (Note 5) // - 45/ | Steady State | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | I _D | 4 3.1 | А |
| Continuous Drain Current (Note 5) V _{GS} = 4.5V | | $T_A = +25$ °C $T_A = +70$ °C | I _D | 5.1 4 | А |
| Maximum Continuous Body Diode Forward Curren | t (Note 5) | I _S | 1.5 | Α | |
| Pulsed Drain Current (10µs pulse, duty cycle = 1% | I _{DM} | 25 | A | | |

Maximum Ratings P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Units | |
|---|----------|--|-----------------|--------------|---|
| Drain-Source Voltage | | V_{DSS} | -40 | V | |
| Gate-Source Voltage | | | V_{GSS} | ±20 | V |
| | | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | I _D | -3.7 -2.9 | А |
| Continuous Drain Current (Note 5) V _{GS} = -10V | t<10s | T _A = +25°C T _A = +70°C | I _D | -4.8 -3.8 | А |
| Steady State | | T _A = +25°C T _A = +70°C | I _D | -2.9 -2.3 | А |
| Continuous Drain Current (Note 5) V _{GS} = -4.5V | t<10s | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | I _D | -3.9 -3.0 | А |
| Maximum Continuous Body Diode Forward Current | (Note 5) | I _S | -1.5 | Α | |
| Pulsed Drain Current (10µs pulse, duty cycle = 1%) | | | I _{DM} | -15 | Α |

Note: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|--|----------------------|-----|------|------|-------|--|
| OFF CHARACTERISTICS (Note 6) | | | • | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 40 | _ | _ | V | $V_{GS} = 0V$, $I_D = 250\mu A$ |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | 1 | μA | V _{DS} = 40V, V _{GS} = 0V |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 6) | | | • | • | | |
| Gate Threshold Voltage | V _{GS(th)} | 1 | _ | 3 | V | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ |
| Static Drain-Source On-Resistance | | _ | 26 | 45 | mΩ | $V_{GS} = 10V, I_D = 3.9A$ |
| Static Dialii-Source Oil-Resistance | R _{DS} (ON) | _ | 35 | 58 | 11122 | V _{GS} = 4.5V, I _D = 3.5A |
| Diode Forward Voltage | V_{SD} | _ | 0.7 | 1 | V | V _{GS} = 0V, I _S = 1.25A |
| DYNAMIC CHARACTERISTICS (Note 7) | | | • | | | |
| Input Capacitance | Ciss | _ | 574 | _ | | V _{DS} = 20V, V _{GS} = 0V, f = 1MHz |
| Output Capacitance | Coss | _ | 87.8 | _ | pF | |
| Reverse Transfer Capacitance | C _{rss} | _ | 38.7 | _ | | |
| Gate resistance | R_g | _ | 1.6 | _ | Ω | V_{DS} = 0V, V_{GS} = 0V, f = 1MHz |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | _ | 5.9 | _ | | |
| Total Gate Charge (V _{GS} = 10V) | Qg | _ | 12.5 | _ | nC | V _{DS} = 20V. I _D = 3.9A |
| Gate-Source Charge | Q_{gs} | _ | 1.7 | _ | IIC | V _{DS} = 20V, I _D = 3.9A |
| Gate-Drain Charge | Q_{gd} | _ | 2.2 | _ | | |
| Turn-On Delay Time | t _{D(on)} | _ | 3.1 | _ | | V _{DD} = 20V, V _{GS} = 10V, |
| Turn-On Rise Time | t _r | _ | 2.6 | _ | | |
| Turn-Off Delay Time | t _{D(off)} | _ | 15 | _ | ns | $R_L = 20\Omega$, $R_G = 6\Omega$, |
| Turn-Off Fall Time | t _f | _ | 5.5 | _ | | |
| Reverse Recovery Time | t _{rr} | _ | 6.5 | _ | ns | 1 - 2 0 4 - 11/44 - 500 4 / |
| Reverse Recovery Charge | Q _{rr} | _ | 1.2 | _ | nC | I _F = 3.9A, di/dt = 500A/μs |

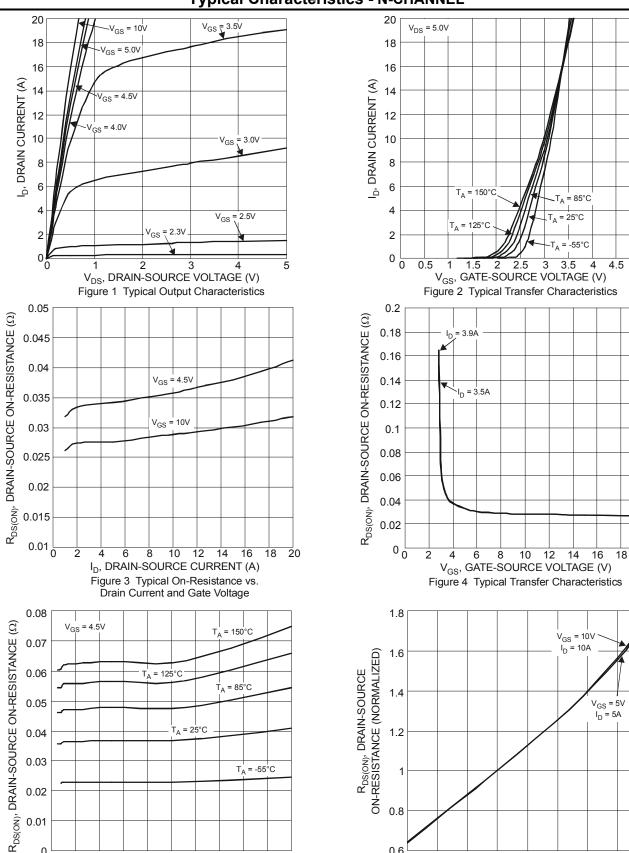
Electrical Characteristics P-CHANNEL (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|---|----------------------|-----|------|------|-------|--|
| OFF CHARACTERISTICS (Note 6) | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -40 | _ | _ | V | $V_{GS} = 0V, I_D = -250\mu A$ |
| Zero Gate Voltage Drain Current | I _{DSS} | | _ | -1 | μΑ | V _{DS} = -40V, V _{GS} = 0V |
| Gate-Source Leakage | I _{GSS} | | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 6) | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | -1 | _ | -3 | V | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ |
| Static Drain-Source On-Resistance | D | _ | 49 | 65 | mΩ | V _{GS} = -10V, I _D = -4.2A |
| Static Drain-Source On-Resistance | R _{DS} (ON) | _ | 73 | 100 | 11122 | $V_{GS} = -4.5V$, $I_D = -3.3A$ |
| Diode Forward Voltage | V_{SD} | _ | -0.7 | -1.2 | V | V _{GS} = 0V, I _S = -1A |
| DYNAMIC CHARACTERISTICS (Note 7) | | | | | | |
| Input Capacitance | C _{iss} | _ | 587 | _ | pF | ., |
| Output Capacitance | Coss | _ | 88.1 | _ | pF | V _{DS} = -20V, V _{GS} = 0V, -f = 1MHz |
| Reverse Transfer Capacitance | C _{rss} | _ | 40.2 | _ | pF | 1 - 1101112 |
| Gate resistance | Rg | _ | 12.3 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ |
| Total Gate Charge (V _{GS} = -4.5V) | Qg | _ | 5.4 | _ | nC | |
| Total Gate Charge (V _{GS} = -10V) | Qg | _ | 11.1 | _ | nC | \/ = 20\/ _ = 4.24 |
| Gate-Source Charge | Q _{gs} | _ | 1.5 | _ | nC | $V_{DS} = -20V, I_D = -4.2A$ |
| Gate-Drain Charge | Q _{gd} | _ | 2 | _ | nC | |
| Turn-On Delay Time | t _{D(on)} | _ | 3.6 | _ | ns | |
| Turn-On Rise Time | t _r | | 2.9 | _ | ns | V _{DD} = -15V, V _{GS} = -10V, |
| Turn-Off Delay Time | t _{D(off)} | _ | 36.3 | _ | ns | $R_G = 6\Omega$, $I_D = -1A$ |
| Turn-Off Fall Time | t _f | | 15.3 | _ | ns | 7 |
| Reverse Recovery Time | t _{rr} | 1 | 15.5 | _ | ns | 1 - 424 - 5004/: |
| Reverse Recovery Charge | Q _{rr} | 1 | 16.9 | _ | nC | $I_F = -4.2A$, di/dt = 500A/ μ s |

6. Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing. Notes:



Typical Characteristics - N-CHANNEL



2

6 8 10 12 14 I_D, DRAIN CURRENT (A)

Figure 5 Typical On-Resistance vs. Drain Current and Temperature

16 18

0 0

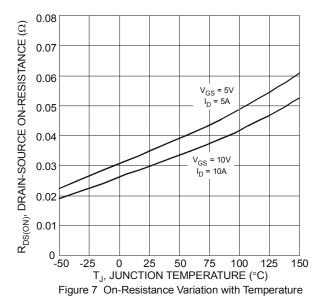
0.6_50

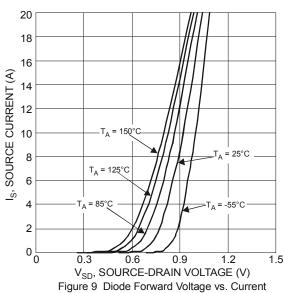
125

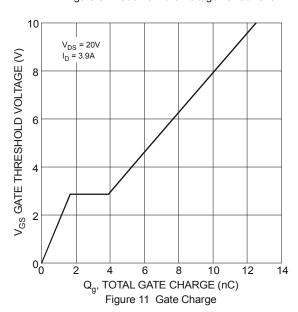
25 0 25 50 75 100 12 T_J, JUNCTION TEMPERATURE (°C)

Figure 6 On-Resistance Variation with Temperature









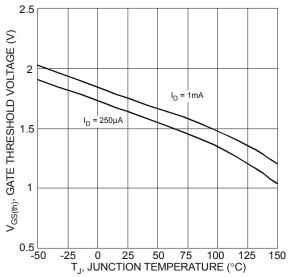
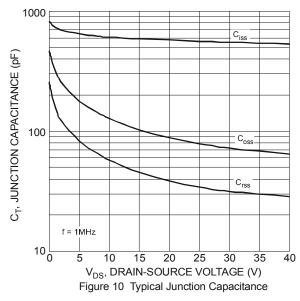
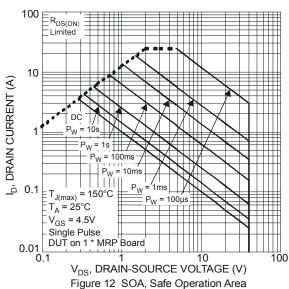


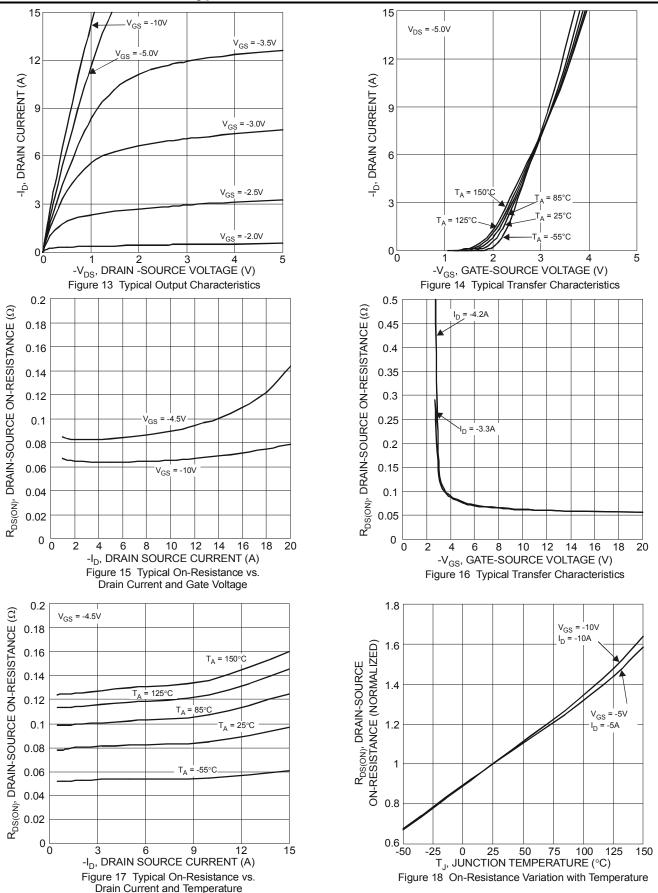
Figure 8 Gate Threshold Variation vs. Ambient Temperature







Typical Characteristics - P-CHANNEL





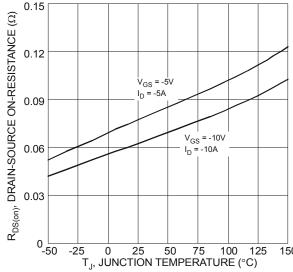
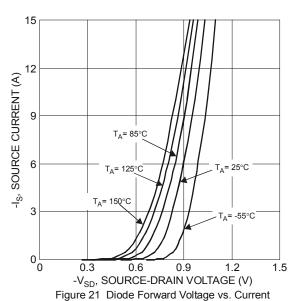
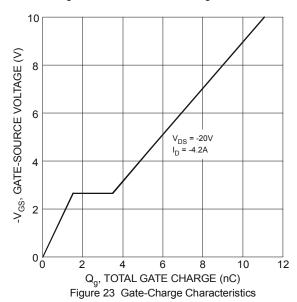


Figure 19 On-Resistance Variation with Temperature





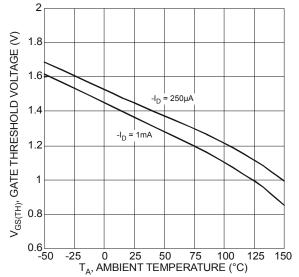
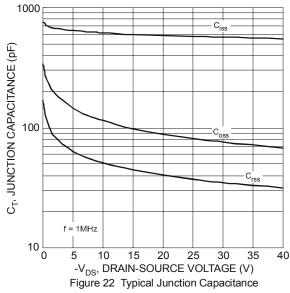
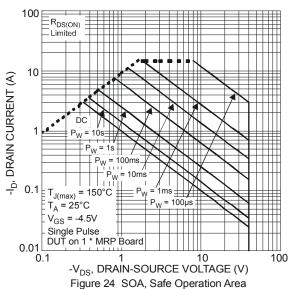
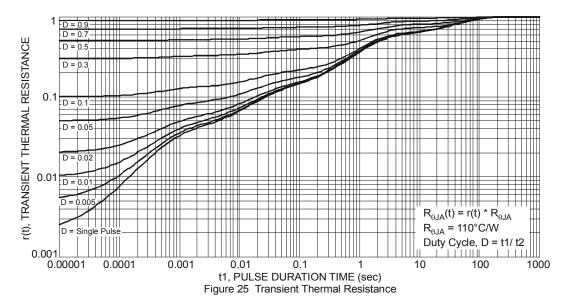


Figure 20 Gate Threshold Variation vs. Ambient Temperature



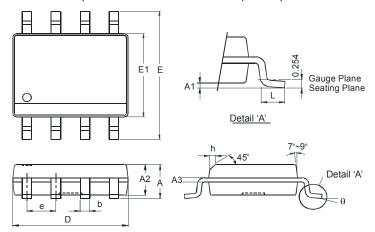






Package Outline Dimensions

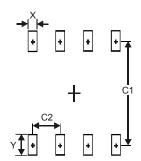
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| SO-8 | | | | | |
|----------------------|------|------|--|--|--|
| Dim | Min | Max | | | |
| Α | - | 1.75 | | | |
| A1 | 0.10 | 0.20 | | | |
| A2 | 1.30 | 1.50 | | | |
| А3 | 0.15 | 0.25 | | | |
| b | 0.3 | 0.5 | | | |
| D | 4.85 | 4.95 | | | |
| Е | 5.90 | 6.10 | | | |
| E1 | 3.85 | 3.95 | | | |
| е | 1.27 | Тур | | | |
| h | - | 0.35 | | | |
| L | 0.62 | 0.82 | | | |
| θ | 0° | 8° | | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| X | 0.60 |
| Υ | 1.55 |
| C1 | 5.4 |
| C2 | 1.27 |



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